

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Mou-Shiung LIN</td> <td>01/18/2002</td> </tr> <tr> <td>Jin-Yuan LEE</td> <td>01/01/2002</td> </tr> <tr> <td>Ching-Cheng HUANG</td> <td>01/18/2002</td> </tr> </tbody> </table>		Name	Execution Date	Mou-Shiung LIN	01/18/2002	Jin-Yuan LEE	01/01/2002	Ching-Cheng HUANG	01/18/2002
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Mou-Shiung LIN	01/18/2002								
Jin-Yuan LEE	01/01/2002								
Ching-Cheng HUANG	01/18/2002								
RECEIVING PARTY DATA									
Name:	MEGIC CORPORATION								
Street Address:	21 R&D FIRST ROAD								
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK								
City:	HSIN-CHU								
State/Country:	TAIWAN								
Postal Code:	300								
PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13159190</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13159190				
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Application Number:	13159190								
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PATENT

Date:

05/17/2013

Total Attachments: 2

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MEG01-013

For ☒ U.S. and/or ☒ Foreign Rights

For ☒ Application or ☐ U.S. Patent

By ☒ Inventor(s) or ☐ Present Owner

### ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

#### ASSIGNOR:

MOU-SHIUNG LIN  
Type or print name of ASSIGNOR

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Nationality

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Republic of China, Taiwan  
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#### ASSIGNEE:

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Taiwan, R.O.C.  
Nationality

and the successors, assigns and legal representatives of the ASSIGNEE

(complete one of the following)

- ☒ the entire right, title and interest
- ☐ an undivided \_\_\_\_\_ percent (\_\_\_\_%) interest for the United States and its territorial possessions  
(check the following box if foreign rights are also to be assigned)
- ☒ and in all foreign countries

In and to any and all improvements which are disclosed in the invention entitled:

Thin Film Semiconductor Package And Emthod Of Fabrication

and which is found in

- (a) ☒ U.S. patent application executed on even date herewith  
(b) ☐ U.S. patent application executed on \_\_\_\_\_  
(c) ☐ U.S. application serial no. \_\_\_\_\_ filed on \_\_\_\_\_  
(d) ☐ U.S. patent no. \_\_\_\_\_ issued \_\_\_\_\_  
(e) ☐ and any legal equivalent thereof in a foreign country, including the right to claim priority  
(also check (e) if foreign application(s) is also being assigned)

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute, thereof, and as to letters patent any re-issue or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I / We have signed this

January 18th, 2002 (Date of signing)

WARNING Date of signing must be the same as the date of execution of the application if item (a) was checked above.

Min-Yuan Lee  
Signature of ASSIGNOR(S)

Ching-Cheng Huang

If ASSIGNOR is a legal entity complete the following information

\_\_\_\_\_  
Type or print the name of the above person authorized to sign on behalf of ASSIGNOR.

\_\_\_\_\_  
Title

Note: No witnessing, notarization or legalization is necessary, if the assignment is notarized or legalized then it will only be prima facie evidence (35 USC 261). Use next page if notarization is desired.

\_\_\_\_\_  
Notarization or Legalization Page Added.